Transistors with Built-in Resistor

DRA2144E0L

DRA2144E0L

Panasonic

Silicon PNP epitaxial planar type

For digital circuit Complementary to DRC2144E

■ Features

- Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: LL

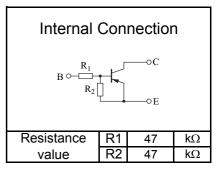
■ Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|--------|-------------|------|
| Collector-base voltage (Emitter open) | VCBO | -50 | V |
| Collector-emitter voltage (Base open) | VCEO | -50 | V |
| Collector current | IC | -100 | mA |
| Total power dissipation | PT | 200 | mW |
| Junction temperature | Tj | 150 | °C |
| Operating ambient temperature | Topr | -40 to +85 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Unit: mm 2.9 0.4 0.16 3 (0. 95) (0. 95) 1.9 1. Base 2. Emitter 3. Collector Panasonic Mini3-G3-B JEITA SC-59A TO-236AA/SOT-23 Code



■ Electrical Characteristics Ta = 25 °C ± 3 °C

Established: 2009-10-29

: 2014-01-22

Revised

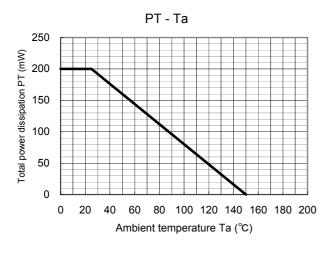
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------|---------------------------|------|-----|-------|------|
| Collector-base voltage (Emitter open) | VCBO | IC = -10 μA, IE = 0 | -50 | | | V |
| Collector-emitter voltage (Base open) | VCEO | IC = -2 mA, IB = 0 | -50 | | | V |
| Collector-base cutoff current (Emitter open) | ICBO | VCB = -50 V, IE = 0 | | | -0.1 | μΑ |
| Collector-emitter cutoff current (Base open) | ICEO | VCE = -50 V, IB = 0 | | | -0.5 | μΑ |
| Emitter-base cutoff current (Collector open) | IEBO | VEB = -6 V, IC = 0 | | | -0.1 | mA |
| Forward current transfer ratio | hFE | VCE = -10 V, IC = -5 mA | 80 | | | - |
| Collector-emitter saturation voltage | VCE(sat) | IC = -10 mA, IB = -0.5 mA | | | -0.25 | V |
| Input voltage | Vi(on) | VCE = -0.2 V, IC = -5 mA | -3.6 | | | V |
| | Vi(off) | VCE = -5 V, IC = -100 μA | | | -0.8 | V |
| Input resistance | R1 | | -30% | 47 | +30% | kΩ |
| Resistance ratio | R1/R2 | | 0.8 | 1.0 | 1.2 | - |

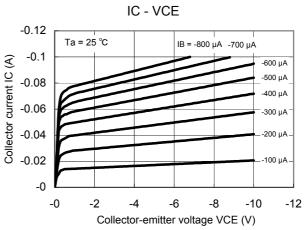
 $Note) \, 1. \quad \text{Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.}$

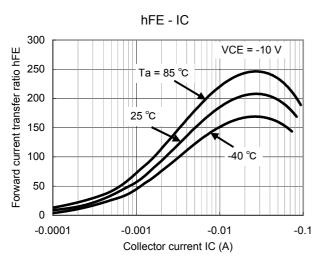
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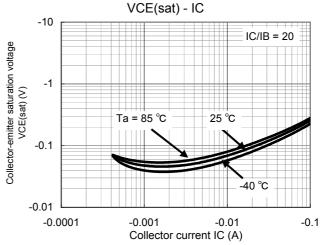
Panasonic

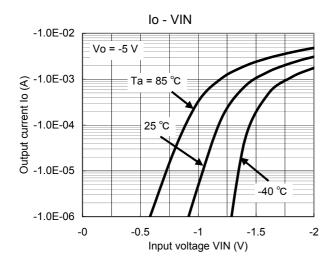
Technical Data (reference)

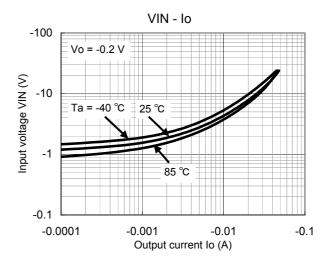












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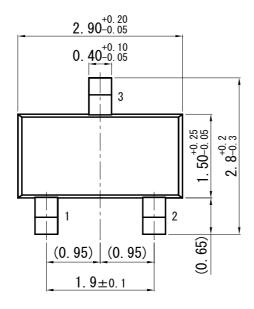
Transistors with Built-in Resistor

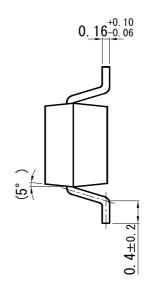
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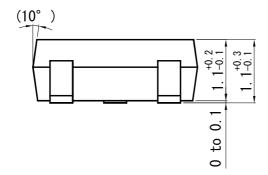
Mini3-G3-B

Panasonic

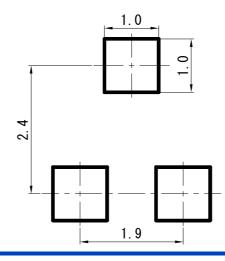
Unit: mm







■ Land Pattern (Reference) (Unit: mm)



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Established: 2009-10-29 Revised: 2014-01-22

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